

□ General Description

This IGBT power module adopts IGBTs and fast recovery diode chips with low conduction loss and low switching loss, enabling designers to achieve high efficiency and excellent reliability.

□ 概述

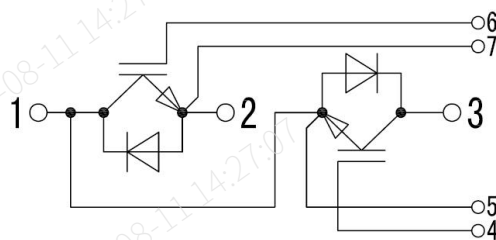
这款 IGBT 功率模块采用低导通损耗和低开关损耗的 IGBT 和快恢复二极管芯片，使设计师能够实现高效率和卓越的可靠性能。



$V_{CE}=1200V$, $I_C=150A$

□ Key Features

- Half-bridge module
- Low inductance
- Standard package
- Ultra low conduction and switching loss



□ 关键特性

- 半桥模块
- 低电感
- 标准封装
- 超低的通态及开关损耗

□ Applications

- AC motor control
- Inverters
- Servo
- UPS (Uninterruptible Power Supplies)
- Electric welding

□ 应用

- 电机控制
- 逆变器
- 伺服系统
- 不间断电源
- 电焊机



□ IGBT/IGBT

● Maximum Rated Values/最大额定值

符号 Symbol	参数 Parameter	工作条件 Conditions	额定值 Ratings	单位 Units
V_{CES}	Collector-emitter voltage 集电极-发射极电压	$T_{vj}=25^{\circ}\text{C}$	1200	V
I_C	Collector current 连续集电极直流电流	$T_c=80^{\circ}\text{C}$, $T_{vj}=150^{\circ}\text{C}$	150	A
V_{GES}	Gate-emitter voltage 栅极-发射极峰值电压	$T_{vj}=25^{\circ}\text{C}$	± 20	V
I_{CRM}	Repetitive peak collector current 集电极重复峰值电流	$t_p=1\text{ms}$, $T_{vj}=25^{\circ}\text{C}$	300	A
P_{tot}	Total power dissipation 总耗散功率	$T_c=25^{\circ}\text{C}$	1000	W

● Characteristics Values/特征值

符号 Symbol	参数 Parameter	工作条件 Conditions	额定值 Ratings			单位 Units
			Min.	Typ.	Max.	
$V_{CE\ sat}$	Collector-Emitter Saturation Voltage 集电极-发射极饱和电压	$I_C=150\text{A}$, $V_{GE}=15\text{V}$, $T_{vj}=25^{\circ}\text{C}$	-	2.3	-	V
		$I_C=150\text{A}$, $V_{GE}=15\text{V}$, $T_{vj}=125^{\circ}\text{C}$	-	2.6	-	V
V_{GEth}	Gate threshold voltage 栅极阈值电压	$V_{CE}=V_{GE}$, $I_C=6\text{mA}$, $T_{vj}=25^{\circ}\text{C}$	5.8	6.1	6.3	V
Q_G	Gate charge 栅极电荷	$V_{GE}=-15\text{V}\dots+15\text{V}$	-	1.1	-	μC
R_{gint}	Internal gate resistance 内部栅极电阻	$T_{vj}=25^{\circ}\text{C}$	-	5	-	Ω
C_{ies}	Input capacitance 输入电容	$T_{vj}=25^{\circ}\text{C}$, $f=1\text{MHz}$, $V_{GE}=0\text{V}$, $V_{CE}=25\text{V}$	-	10.3	-	nF
C_{res}	Reverse capacitance 反向传输电容		-	0.66	-	nF
I_{CES}	Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE}=1200\text{V}$, $V_{GE}=0\text{V}$, $T_{vj}=25^{\circ}\text{C}$	-	-	1.0	mA
I_{GES}	Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE}=0\text{V}$, $V_{GE}=20\text{V}$, $T_{vj}=25^{\circ}\text{C}$	-	-	400	nA
$t_{d\ on}$	Turn-on delay time 开通延迟时间	$V_{CC}=600\text{V}$, $I_C=150\text{A}$, $R_{GON}=3.3\Omega$, $T_{vj}=25^{\circ}\text{C}$	-	230	-	ns
		$T_{vj}=125^{\circ}\text{C}$	-	233	-	ns

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t_r	Rise time 上升时间	$V_{GE}=+15V, L_o=80nH,$ inductive load	$T_{vj}=25^{\circ}C$	-	90	-	ns
			$T_{vj}=125^{\circ}C$	-	95	-	ns
$t_{d\ off}$	Turn-off delay time, 关断延迟时间		$T_{vj}=25^{\circ}C$	-	330	-	ns
			$T_{vj}=125^{\circ}C$	-	380	-	ns
t_f	Fall time 下降时间		$T_{vj}=25^{\circ}C$	-	148	-	ns
			$T_{vj}=125^{\circ}C$	-	168	-	ns
E_{on}	Turn-on energy loss 开通损耗能量		$T_{vj}=25^{\circ}C$	-	7.6	-	mJ
			$T_{vj}=125^{\circ}C$	-	14.8	-	mJ
E_{off}	Turn-off energy loss 关断损耗能量		$T_{vj}=25^{\circ}C$	-	6.3	-	mJ
			$T_{vj}=125^{\circ}C$	-	8.9	-	mJ

□ FRD/二极管

● Maximum Rated Values/最大额定值

符号 Symbol	参数 Parameter	工作条件 Conditions	额定值 Ratings	单位 Units
V_{RRM}	Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^{\circ}C$	1200	V
I_F	Forward current of diode 连续正向直流电流	$T_C = 25^{\circ}C$	150	A
I_{FRM}	Repetitive peak forward current 正向重复峰值电流	$t_p=1ms, T_{vj} = 25^{\circ}C$	300	A

● Characteristics Values/特征值

符号 Symbol	参数 Parameter	工作条件 Conditions		额定值 Ratings			单位 Units
				Min.	Typ.	Max.	
V _F	Forward voltage 正向电压	I _F =150A, V _{GE} =0V	T _{vj} =25℃	-	2.2	-	V
			T _{vj} =125℃	-	2.25	-	V
I _{RM}	Peak reverse recovery current 反向恢复峰值电流	I _F =150A, V _R =600V, di _F /dt=1300A/us	T _{vj} =125℃	-	105	-	A
Q _r	Recovered charge 恢复电荷		T _{vj} =125℃	-	19	-	uC
t _{rr}	Reverse recovery time		T _{vj} =125℃	-	420	-	ns
E _{rec}	Reverse recovery energy 反向恢复损耗		T _{vj} =25℃	-	8	-	mJ
		T _{vj} =125℃	-	11	-		

□ **Module/模块**

符号 Symbol	参数 Parameter	工作条件 Conditions	额定值 Ratings			单位 Units
			Min.	Typ.	Max.	
T_{vjmax}	Maximum junction temperature 最大结温	-	-	-	175	℃
T_{vjop}	Temperature under switching conditions 工作结温	-	-40	-	150	℃
T_{stg}	Storage temperature 储存温度	-	-40	-	125	℃
R_{thjc} IGBT	IGBT, thermal resistance, junction to case 结-外壳热阻	per IGBT 单个 IGBT	-	-	0.15	K/W
R_{thjc} Diode	Diode, thermal resistance, junction to case 结-外壳热阻	per diode 单个二极管	-	-	0.20	K/W
V_{isol}	Isolation test voltage 绝缘测试电压	$f = 50\text{Hz}$, $t = 1\text{min.}$	2.5	-	-	KV
G	Weight 重量	-	-	320	-	g
-	Cree page distance 爬电距离	Terminal to terminal 端子到端子	-	21.5	-	mm
-		Terminal to base 端子到底板	-	29.4	-	
-	Clearance distance in air 空气间隙	Terminal to terminal 端子到端子	-	9	-	
-		Terminal to base 端子到底板	-	29	-	
M_1	Mounting torque for module mounting 模块的安装扭矩	Screw M6 M6 螺栓	3	-	6	N.m
M_2	Terminal connection torque 端子的连接扭矩	Screw M6 M6 螺栓	2.5	-	5	N.m
-	Internal isolation 内部绝缘	ceramics 陶瓷	Al_2O_3			
-	Material of module baseplate 模块基板材料	-	Cu			
L x W x H	Dimensions 尺寸	-	107.2 x 62.0 x 31.0			

Note: The typical reference values in the above parameters are based on laboratory test data under encapsulation conditions and are not to be used as a basis for production test acceptance.

注：以上参数中的典型参考值基于封装条件下实验室测试数据得出，不作为生产测试验收依据。

□ Characteristics Diagrams/特性曲线

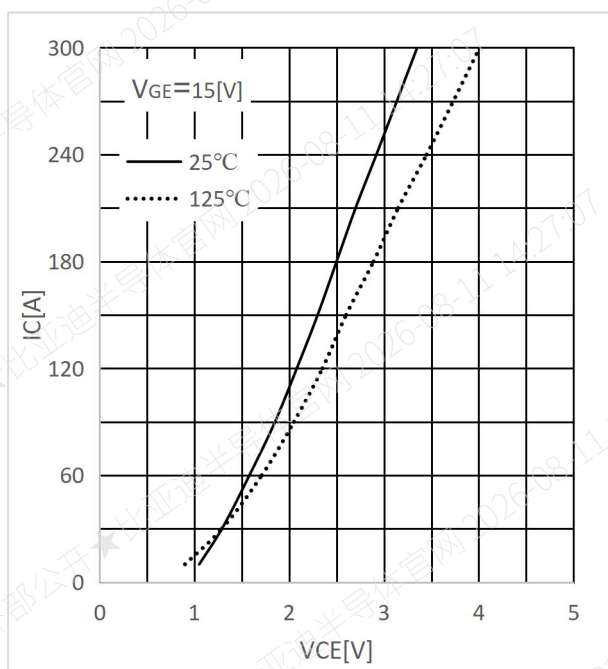


Fig.1 Output Characteristics

图 1 输出特性

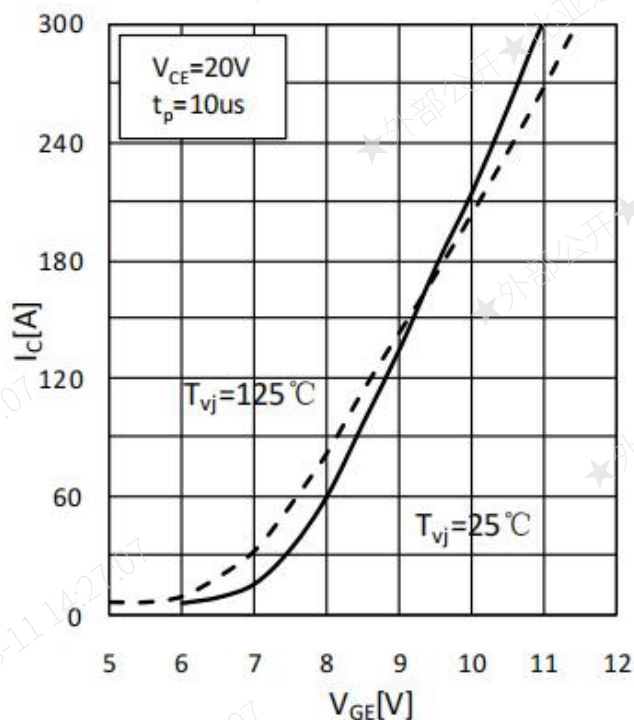


Fig.2 Transfer Characteristics

图 2 传输特性

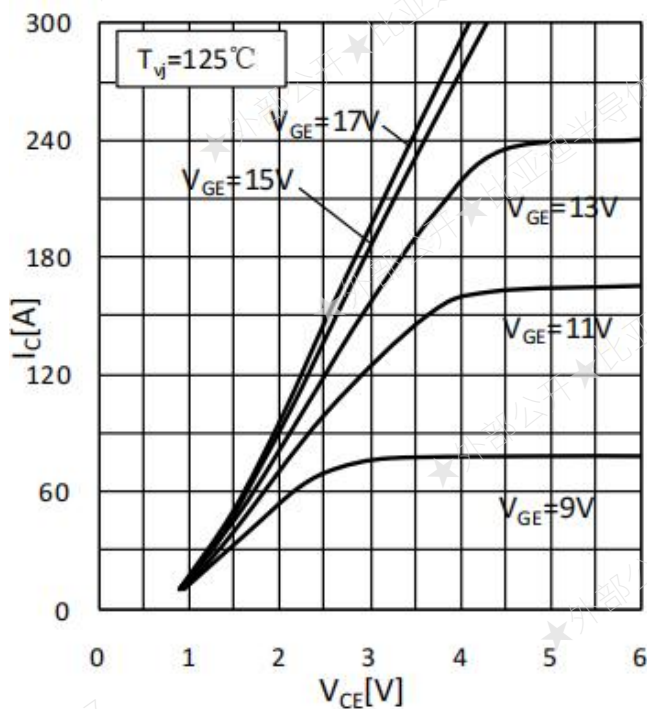


Fig.3 Output Characteristics

图 3 输出特性

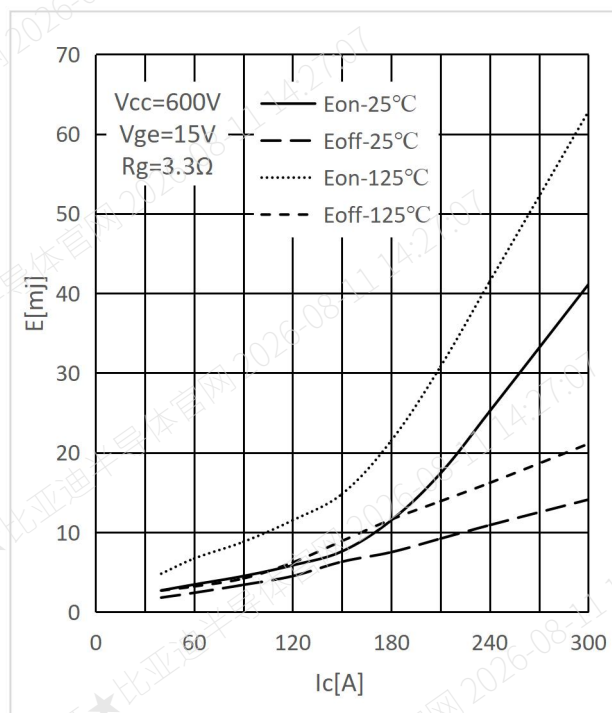


Fig.4 Switching Loss vs. Collector Current

图 4 开关损耗和集电极电流

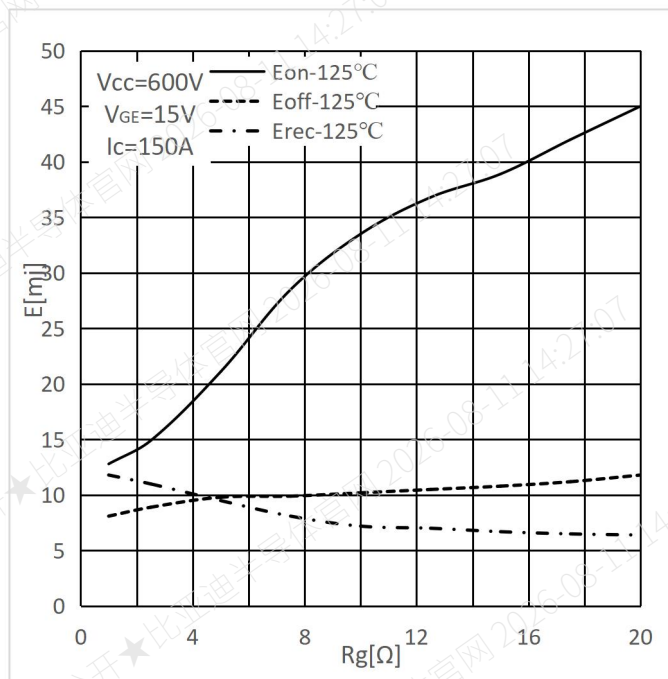


Fig.5 Switching Loss vs. Gate Resistor

图 5 开关损耗和门极电阻

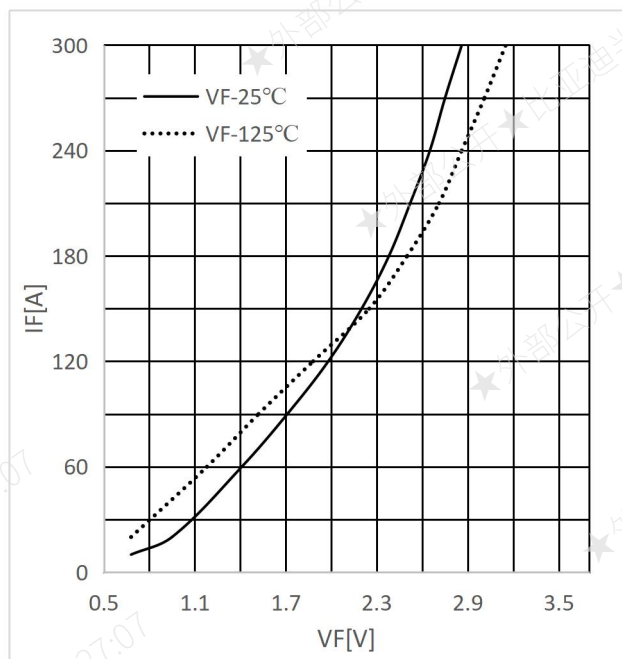


Fig.6 Forward Characteristics

图 6 正向特性

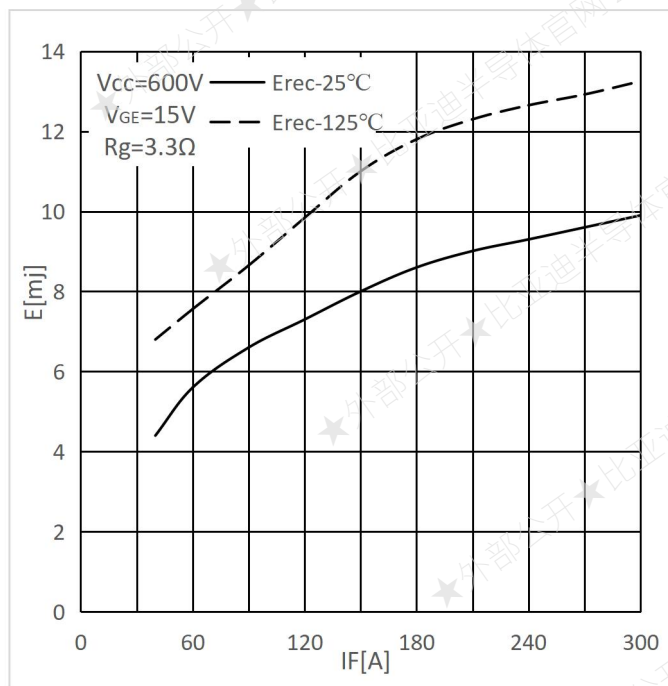


Fig.7 Reverse recovery Energy

图 7 反向恢复损耗

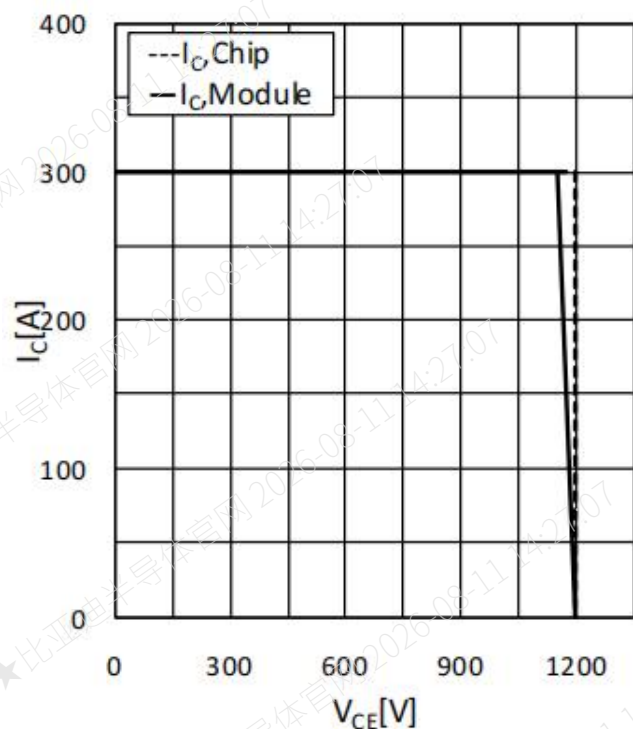


Fig. 8 Reverse Bias safe operating area

图 8 反偏安全工作区

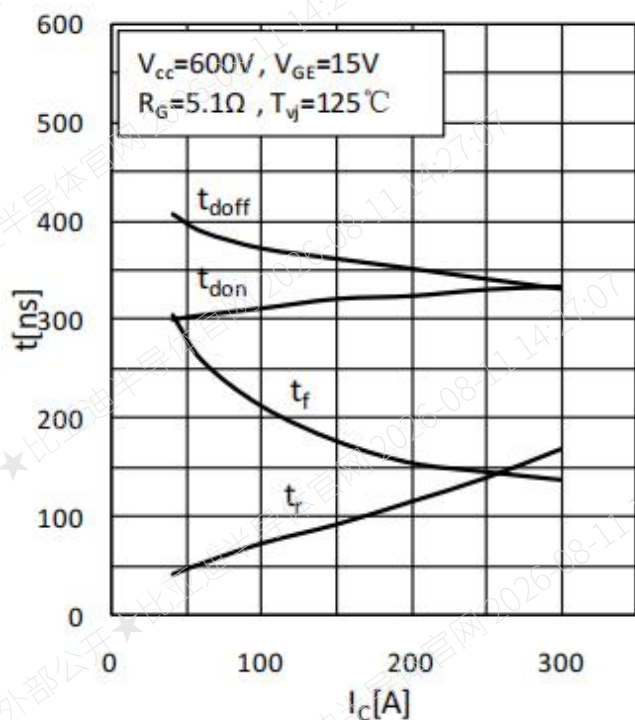


Fig.9 Typ. Switching Times vs. I_c

图 9 开关时间和集电流

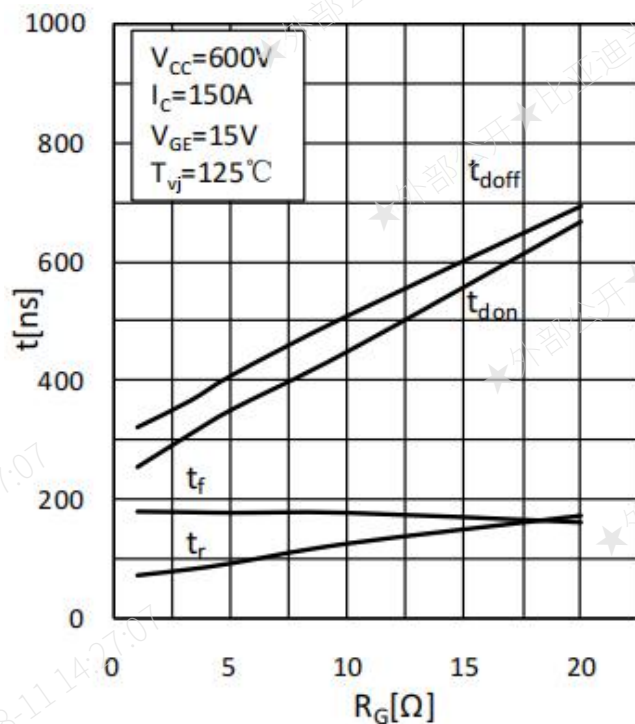


Fig.10 Typ. Switching Times vs. Gate Resistor R_G

图 10 开关时间和门极电阻

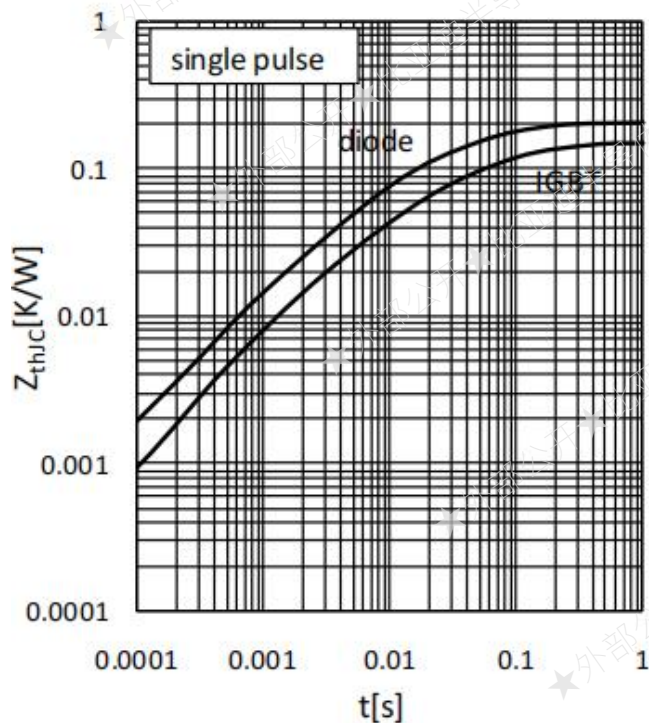


Fig.11 Transient Thermal Impedance

图 11 瞬态热阻

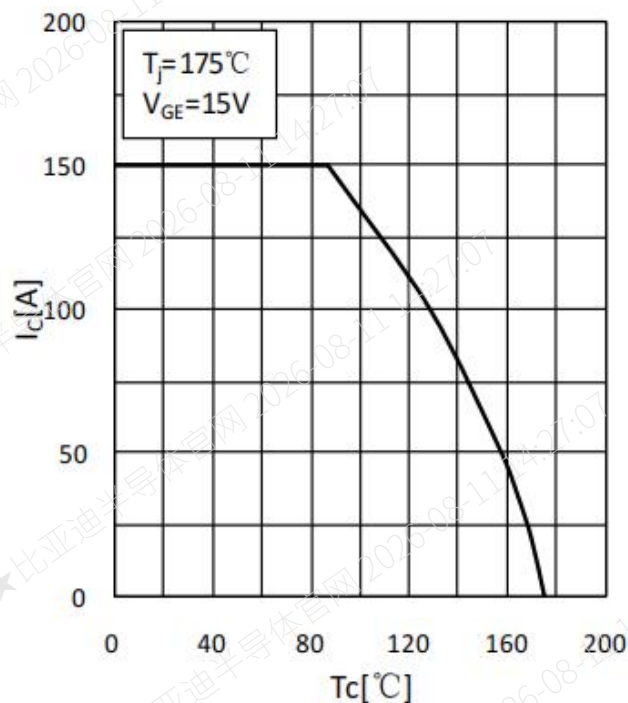
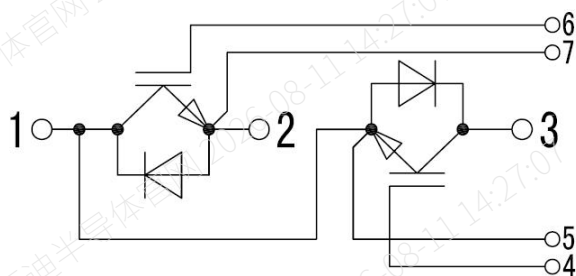


Fig.12 Rate Current vs. Temperature (T_c)

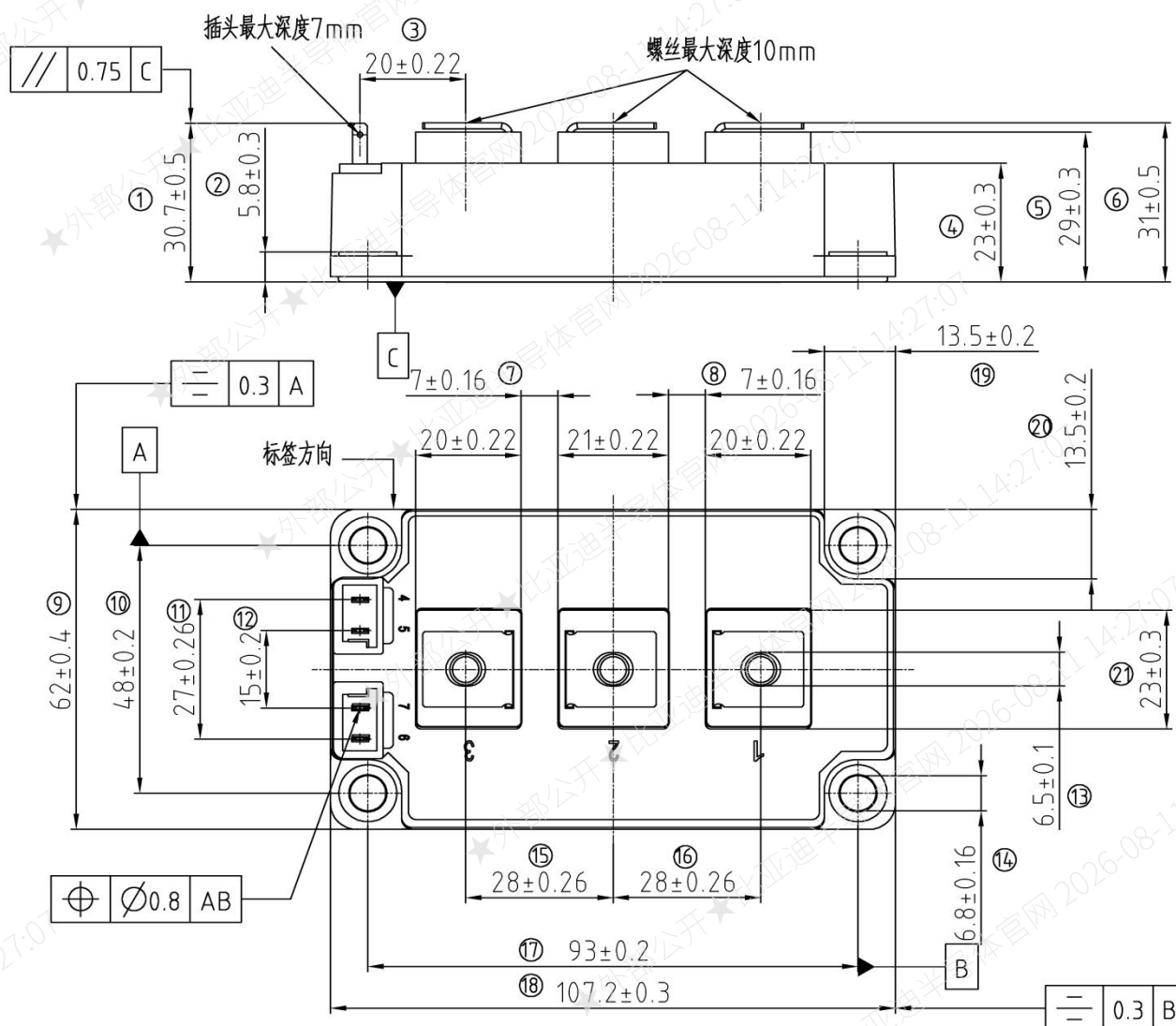
图 12 额定电流和温度

● Circuit Diagram/接线图



- | | |
|----------------------|--------------|
| (1) AC Output | (1) 交流输出端 |
| (2) N-Negative Power | (2) N-负电极 |
| (3) P-Positive Power | (3) P-正电极 |
| (4) GH-Gate High | (4) GH-上桥门极 |
| (5) EH-Emitter High | (5) EH-上桥发射极 |
| (6) GL-Gate Low | (6) GL-下桥门极 |
| (7) EL-Emitter Low | (7) EL-下桥发射极 |

□ Package outlines/封装尺寸





DISCLAIMER 免责声明

- Applications: This product is suitable for industrial electrical applications (including but not limited to: industrial motor drives, frequency converters, UPS, photovoltaic inverters, energy storage converters, industrial welding equipment, power quality devices (SVG, APF), etc.)

使用范围：本产品适用于工业级电气应用（包括但不限于：工业电机驱动、变频器、不间断电源（UPS）、光伏逆变器、储能变流器、工业焊接设备、电能质量设备（如 SVG、APF）等）

- Warranty Period: Unless otherwise agreed in the COOPERATION AGREEMENT Or Other WRITTEN DOCUMENTS, The warranty period for the product described in this specification is 12 months from the date of shipment.

质保期：除双方在合作协议或其他书面文件中另行约定外，本规格书所述产品质保期自出货起 12 个月。

- Special Instructions:

特别说明：

- Correct and Safety Use of Power Module: Unsuitable operation (such as electrical, mechanical stress and so on) may lead to damage of power modules. Please pay attention to the following descriptions and use this product according to the guidance.

功率模块安全正确的使用方法：不当的操作（如电应力、机械应力等）可能导致模块损毁。请注意以下介绍，并根据指导来使用本产品。

- During Transit: Tossing or dropping of a carton may damage devices inside. Devices exposed to moisture may result in failure. Special care should be taken during rainy or snowy weather to implement protective measures preventing the device from getting wet.

运输过程中：包装箱颠簸或坠落可能导致内部器件损毁；器件遇水受潮将导致故障失效。在雨雪天气尤其要注意保护器件防止淋湿。

- Storage: The temperature and humidity of the storage place should be $20\pm 5^{\circ}\text{C}$ and 30% ~ 60%RH respectively. The performance and reliability of devices may be jeopardized if devices are stored in an environment far above or below the range indicated above.

贮存：贮存地点温度与湿度应分别控制在 $20\pm 5^{\circ}\text{C}$ 和 30%~60%RH。如果贮存环境远高于或低于指示的变化范围，将危害器件的性能与可靠性。

- Prolonged Storage: When storing devices more than one year, dehumidifying measures should be provided for the storage place. When using devices after a long period of storage, please inspect them to ensure there are no scratches, dust, rust, or other defects on the surface.

长期贮存：当存储器件时间超过一年，贮存地点应当采取去湿措施。器件经过长期存放使用时，检查器件确保外观没有刮伤，灰尘，锈迹等。

- Operating Environment: Devices should not be exposed to water, organic solvents, corrosive gases, explosive gases, fine particles, or corrosive agents, since any of those can lead to a serious accident.

应用环境：器件不应当暴露在水，有机溶剂，腐蚀性气体、易燃易爆性气体，微尘，腐蚀性药剂中，上述



任何一种情况都会导致严重事故。

- **Anti-electrostatic Measures:** Following precautions should be taken for gated devices to prevent static buildup which could damage the devices:

防静电措施：带栅极器件应采取以下预警来防止可以损毁器件的静电生成：

1. Static electricity of human bodies and cartons and/or excessive voltage applied across the gate to emitter may damage and rupture devices. Sense-emitter and temperature-sensor are also vulnerable to excessive voltage. The basis of anti-electrostatic is suppression of build-up and quick dissipation of the charged electricity.

门极与发射极间产生的人体静电、包装箱静电和过电压将损毁或击穿器件。采样发射极和温度传感器同样容易受到过压损毁。防静电底板可以抑制电荷生成并快速耗散。

2. Containers that are susceptible to static electricity should not be used for transit or for storage.

不要用易受静电影响的容器运输或贮存器件。

3. Signal terminals to emitter should be always shorted with a carbon cloth or the like until right before a module is used. Never touch the signal terminals with bare hands.

发射极信号端子应一直用碳纤维布或类似物短接直到模块使用前。任何情况下不要徒手碰触信号端子。

4. During the installation process, it is necessary to always maintain the equipment and the operator's body in contact with the ground after removing carbon fiber cloth or similar materials. It is advisable to cover the workstation and its surrounding floor with conductive mats and ground them.

安装过程中始终保持设备和操作人员的身体接触地面（移除碳纤维布或类似物后）。用导电垫覆盖工作地点及周围地板并使其接地。

5. Use soldering irons with grounded tips.

使用接地的烙铁头。

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